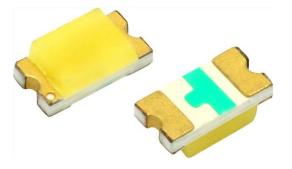
VLMW1300



Vishay Semiconductors

Highbright 0603 ChipLED



DESCRIPTION

The new 0603 ChipLED series have been designed in the smallest SMD package. This innovative 0603 ChipLED technology opens the way to

- Smaller products of higher performance
- More design in flexibility
- Enhanced applications

The 0603 LED is an obvious solution for small-scale products that are expected to work reliably in an arduous environment.

This package is filled with a mixture of epoxy and yellow converter.

This yellow converter converts the blue emission partially to yellow, which mixes the remaining blue to give white.

PRODUCT GROUP AND PACKAGE DATA

- Product group: LED
- Package: SMD 0603 ChipLED
- Product series: standard
- Angle of half intensity: ± 65°

FEATURES

- High efficient InGaN technology
- Super thin ChipLED with exceptional brightness 1.6 mm x 0.8 mm x 0.55 mm (L x W x H)
- High reliability PCB based
- Temperature range -20 °C to +80 °C
- Chromaticity coordinate categorized according to CIE 1931 per packing unit
- Typical color temperature 7000 K
- EIA standard package
- Compatible to IR reflow soldering
- Available on 7" diameter reel
- Preconditioning according to JEDEC[®] level 2a
- ESD-sensitive device
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Telecommunication: indicator and backlighting in telephone and fax
- · Backlighting for audio and video equipment
- Backlighting in office equipment
- Indoor and outdoor message boards
- Flat backlight for LCDs, switches, and symbols

PARTS TABLE														
PART	COLOR	LUMINOUS INTENSITY (mcd)		at I _F	COORDINATE (x, y)		at I _F			at I _F	TECHNOLOGY			
		MIN.	TYP.	MAX.	(mA)	MIN.	TYP.	MAX.	(mA)	MIN.	TYP.	MAX.	(mA)	
VLMW1300-GS08	White	45	-	180	5	-	0.294, 0.286	-	5	2.70	-	3.15	5	InGaN/ yellow converter

ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25 \text{ °C}$, unless otherwise specified) VLMW1300							
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT			
DC forward current	T _{amb} ≤ 25 °C	١ _F	20	mA			
Surge forward current	t _p ≤ 10 μs	I _{FSM}	0.1	А			
Power dissipation		Pv	70	mW			
Operating temperature range		T _{amb}	-20 to +80	°C			
Storage temperature range		T _{stg}	-55 to +105	°C			
Thermal resistance junction/ambient		R _{thJA}	550	K/W			

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1 For technical questions, contact: <u>LED@vishay.com</u> Document Number: 82435



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OPTICAL AND ELECTRICAL CHARACTERISTICS ($T_{amb} = 25 \text{ °C}$, unless otherwise specified) VLMW1300, WHITE								
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT		
Luminous intensity	I _F = 5 mA	Ι _V	45	-	180	mcd		
Chromatically coordinate x acc. to CIE 1931	I _F = 5 mA	х	-	0.294	-			
Chromatically coordinate y acc. to CIE 1931	I _F = 5 mA	У	-	0.286	-			
Angle of half intensity	I _F = 5 mA	φ	-	± 65	-	deg		
Forward voltage	I _F = 5 mA	V _F	2.70	-	3.15	V		
Reverse current ⁽¹⁾	V _R = 5 V	I _R	-	10	-	μA		

Note

⁽¹⁾ Driving the LED in reverse direction is suitable for short term application

LUMINOUS INTENSITY CLASSIFICATION							
GROUP	LUMINOUS INTENSITY (mcd) at 5 mA						
	MIN.	MAX.					
Р	45	71					
Q	71	112					
R	112	180					

Note

Luminous intensity is tested at a current pulse duration of 25 ms ٠ and an accuracy of ± 15 %.

The above type numbers represent the order groups which include only a few brightness groups. Only one group will be shipped on each reel (there will be no mixing of two groups on each reel). In order to ensure availability, single brightness groups will not be orderable.

In a similar manner for colors where wavelength groups are measured and binned, single wavelength groups will be shipped in any one reel.

In order to ensure availability, single wavelength groups will not be orderable.

FORWARD VOLTAGE CLASSIFICATION	
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GROUP	FORWARD VOLTAGE (V)				
GNOUP	MIN.	MAX.			
A	2.7	2.85			
В	2.85	3.0			
С	3.0	3.15			

Note

• Forward voltage is measured with a tolerance of ± 0.1 V.

CHROMATICITY COORDINATED GROUPS FOR WHITE SMD LED								
	X	Y		X	Y			
	0.274	0.226		0.294	0.286			
S1	0.274	0.258		0.294	0.319			
51	0.294	0.286	- 54	0.314	0.347			
	0.294	0.254		0.314	0.315			
	0.274	0.258		0.314	0.282			
S2	0.274	0.291	05	0.314	0.315			
52	0.294	0.319	S5	0.334	0.343			
	0.294	0.286		0.334	0.311			
	0.294	0.254		0.314	0.315			
S3	0.294	0.286	S6	0.314	0.347			
53	0.314	0.315		0.334	0.376			
	0.314	0.282		0.334	0.343			

Note

• Chromaticity coordinate groups are tested at a current pulse duration of 25 ms and a tolerance of ± 0.01.



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TYPICAL CHARACTERISTICS (Tamb = 25 °C, unless otherwise specified)

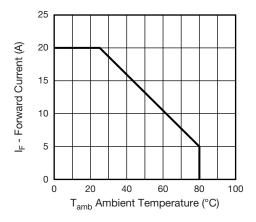


Fig. 1 - Forward Current vs. Ambient Temperature

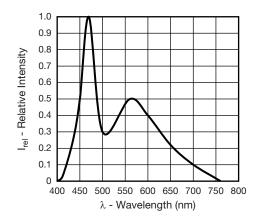


Fig. 2 - Relative Intensity vs. Wavelength

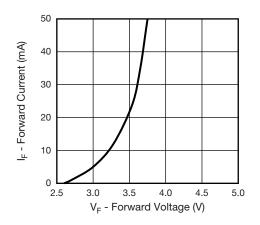


Fig. 3 - Forward Current vs. Forward Voltage

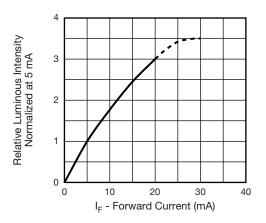


Fig. 4 - Relative Luminous Intensity vs. Forward Current

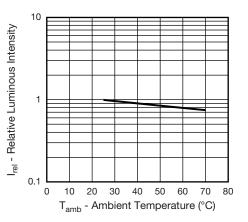


Fig. 5 - Relative Luminous Intensity vs. Ambient Temperature

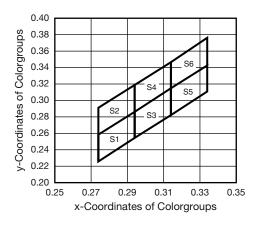


Fig. 6 - Coordinates of Colorgroups

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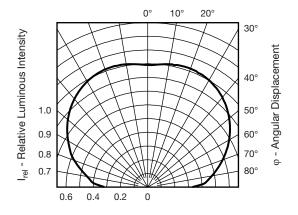
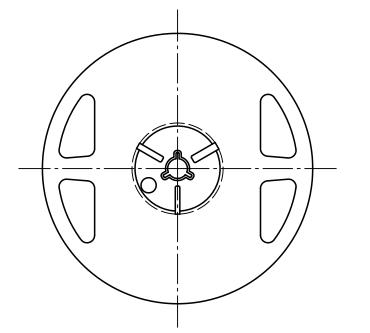
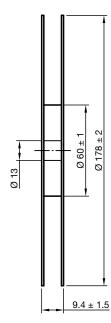
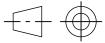


Fig. 7 - Relative Luminous Intensity vs. Angular Displacement

REEL DIMENSIONS in millimeters







technical drawings according to DIN specifications

Drawing-No.: 9.800-5122.01-4 Issue: 2; 03.11.11 22611

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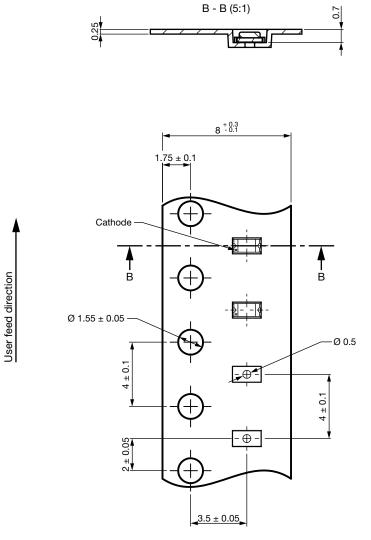
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TAPE DIMENSIONS in millimeters





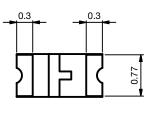
technical drawings according to DIN specifications

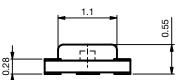
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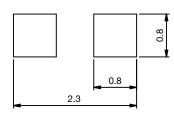
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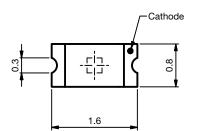
PACKAGE DIMENSIONS in millimeters





Recommended solder pad footprint









technical drawings according to DIN specifications

Not indicated tolerances ± 0.2

Drawing-No.: 6.541-5091.01-4 Issue: 1; 17.10.11 22613

IR Reflow Soldering Profile for lead (Pb)-free Soldering Preconditioning acc. to JEDEC Level 2a

SOLDERING PROFILE

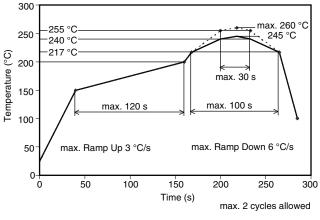


Fig. 8 - Vishay Lead (Pb)-free Reflow Soldering Profile (according to J-STD-020C)

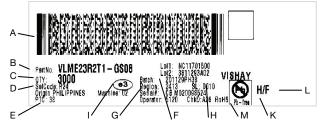


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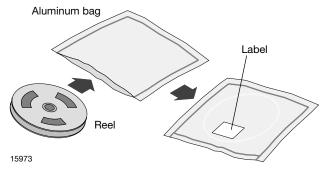
BAR CODE PRODUCT LABEL (Example)



- A. 2D barcode
- B. PartNo = Vishay part number
- C. QTY = Quantity
- D. SelCode = selection code (binning)
- E. PTC = Code of manufacturing plant
- F. Batch = date code: year / week / plant code
- G. Region code
- H. SL = sales location
- I. Terminations finishing
- J. Lead (Pb)-free symbol
- K. Halogen-free symbol
- L. RoHS symbol

DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



FINAL PACKING

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

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RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

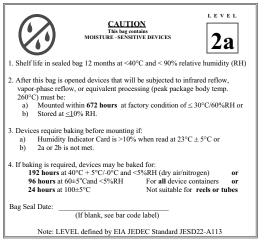
After more than 672 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition: 192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air/nitrogen)

or 96 h at 60 °C + 5 °C and < 5 % RH for all device containers or

24 h at 100 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC standard JESD22-A112 level 2a label is included on all dry bags.



Example of JESD22-A112 level 2a label

ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD **BAR CODE LABEL**

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



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